



PRODUCT DATASHEET



- ▶ PCB / CHIP LED
- ▶ 120<u>9 (3224) 2.5t</u>
 - Sky White (9900K)

Release Date: 11 August 2015 Version: A1.0

NOW10S62RV



RÓHS Compliant



FEATURES:

- Package: PCB / CHIP LED Top View Package
- Forward Current: 20mA
- Forward Voltage (typ.): 3.1V
- Luminous Intensity (typ.): 140mcd@20mA
- Colour: Sky White
- CCT: 9900K
- Viewing angle: 130°
- Materials:

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- Die: InGaN
- Resin: Epoxy (Yellow Diffused)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- Grouping parameters:
 - Forward voltage
 - Luminous intensity
- CIE Chromaticity
- Soldering methods: Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with 1500/reel, ø180mm (7")



APPLICATIONS:

- Indication Light
- Switch Light
- 3C Application





CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125	mA
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	111	mW
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+85	°C

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition	
Forward Voltage	$V_{\rm F}$	2.8	3.1	3.7	V	I _F =20mA	
Luminous Intensity	I_V	80	140	250	mcd	I _F =20mA	
Chromaticity	х	0.2500	0.2800	0.3300		L 20m A	
Coordinates	Y	0.2400	0.2900	0.3400		I _F =20mA	
Colour Temperature	ССТ	5600	9900	46500	к	I _F =20mA	
Viewing Angle	20 _{1/2}		130		deg	I _F =20mA	

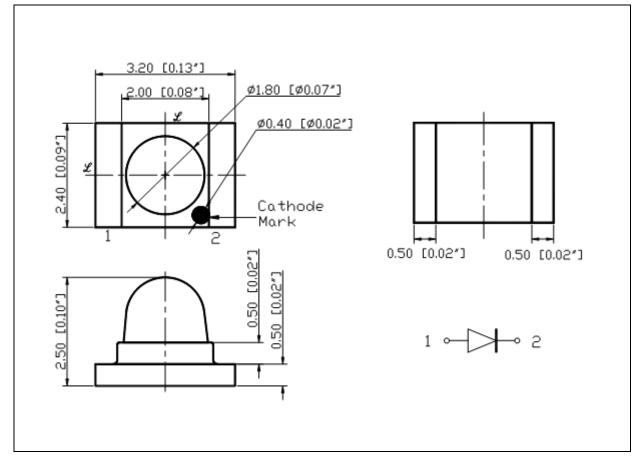
1. Luminous intensity (I_v) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle(2 $\theta_{1/2}$) ±5%

2. IS standard testing



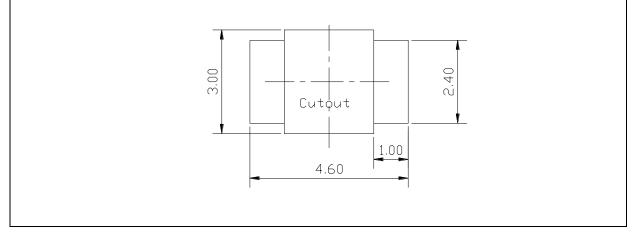
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.

BINNING GROUPS:



Forward Voltage Classifications (I_F = 20mA):

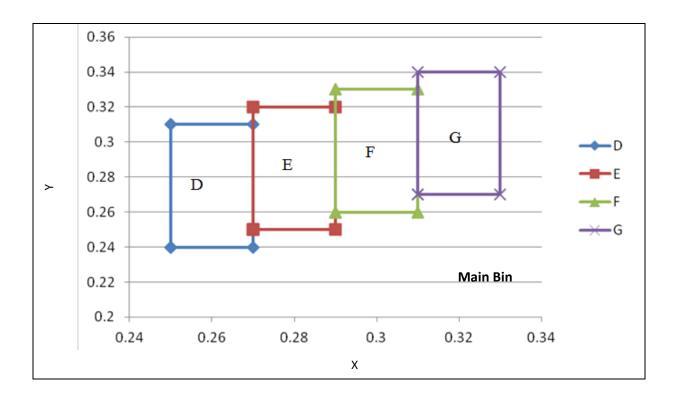
Code	Min.	Max.	Unit
F	2.8	3.1	
G	3.1	3.4	V
н	3.4	3.7	

Luminous Intensity Classifications ($I_F = 20mA$):

Code	Min.	Max.	Unit
I	80	100	
J	100	125	
к	125	160	mcd
L	160	200	
М	200	250	



CIE CHROMATICITY DIAGRAM:

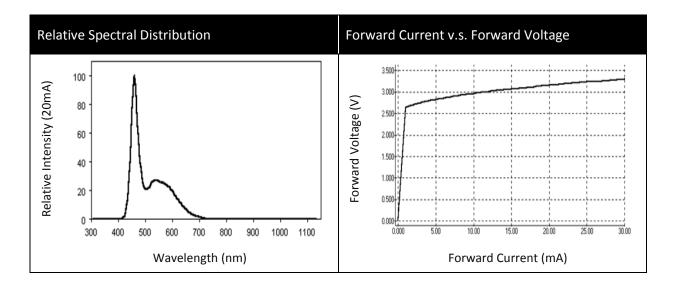


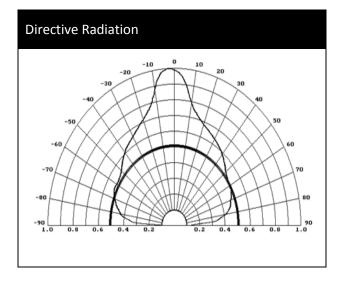
Chromaticity Coordinates Classifications ($I_F = 300$ mA):

		L	2		3		4	
	Х	Y	Х	Y	Х	Y	Х	Υ
D	0.2500	0.2400	0.2500	0.3100	0.2700	0.3100	0.2700	0.2400
E	0.2700	0.2500	0.2700	0.3200	0.2900	0.3200	0.2900	0.2500
F	0.2900	0.2600	0.2900	0.3300	0.3100	0.3300	0.3100	0.2600
G	0.3100	0.2700	0.3100	0.3400	0.3300	0.3400	0.3300	0.2700



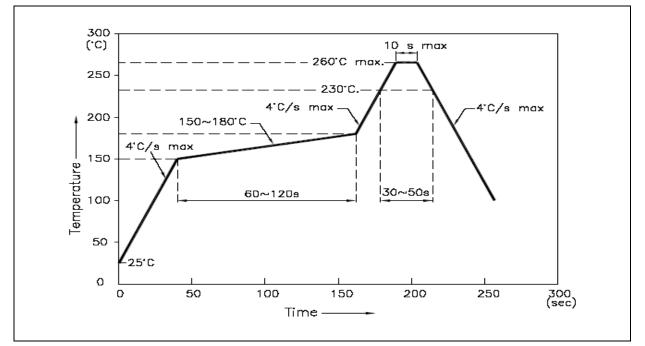
ELECTRO-OPTICAL CHARACTERISTICS:







RECOMMENDED SOLDERING PROFILE:



Lead-free Solder:

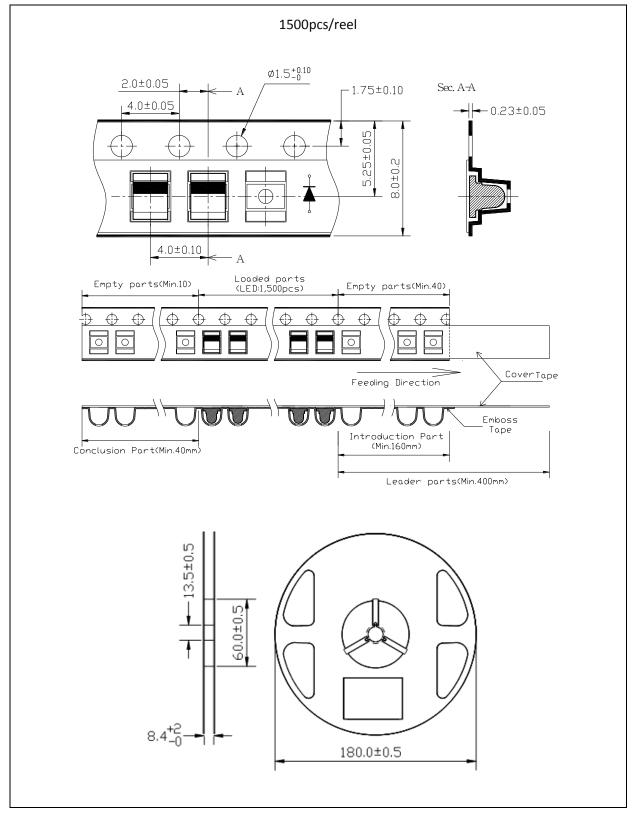
Note:

- 1. Recommend reflow temperature 245°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

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Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	11/08/2015	Datasheet set-up.